- Latched Data Inputs Serve as Buffer Register and Can also:
 - Synchronize Data Acquisition "Debounce" Mechanical Switch Input
- Cascading Input P0 and Output P1 Provides "Busy"Signal Inhibiting All Lower-Order Bits
- Full TTL Compatibility
- Use for:

Priority Interrupt
Synchronous Priority Line Selection

description

The SN54278 and SN74278 each consist of four data latches, full priority output gating, and a cascading gate. The highest-order data applied at a D latch input is transferred to the appropriate Y output while the strobe input is high, and when the strobe goes low all data is latched. The cascading input P0 is fully overriding and on the highest-order package this input must be held at a low logic level. The P1 output is intended for connection to the P0 input of the next lower-order package and will provide a "busy" (high-level) signal to inhibit all subsequent lower-order packages.

After the overriding P0 input, the order of priority is D1, D2, D3, and D4, respectively, within the package.

SN54278 . . . J OR W PACKAGE SN74278 . . . N PACKAGE (TOP VIEW)

STRB	ďг	U14	Vcc
D3		13	D2
D4	□3	12	D1
P0		11	NC
P1	□5	10	Y1
Y4	□6	9	Y2
GND	ď٦	8	Y3

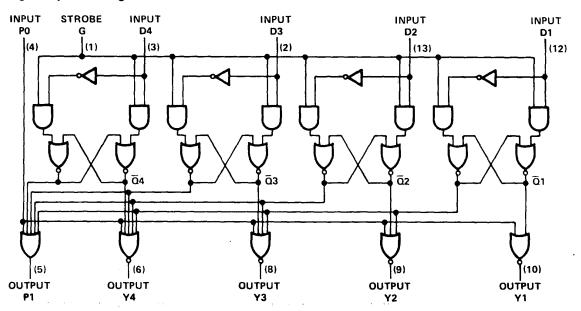
NC-No internal connection

FUNCTION TABLE

	INPUTS						L	OUTPUTS								
L		****				LA	TCH	NO	DES]		
PO	G	D1	D2	D3	D4	Q1	Q2	ŌЗ	Q4	Y1	Y2	Υ3	Y4	P1		
L	Н	Н	Х	X	X	L	X	Х	Х	Ι	L	L	L	н		
L	Н	L	Н	X	X	Н	L	X	X	L	Н	L	L	н		
L	Н	L	L	Н	Х	Н	Н	L	Х	L	L	Н	L	н		
L	Н	L	L	L	н	н	Н	Н	L	L	L	L	Н	н		
L_	Н	L	L	L	L	Н	Н	<u>H</u>	Н	L	L	L	L	L		
ĺ										Sai	me fi	uncti	on o	fQ		
L	L	х	X	X	X	La	tche	d wh	en	no	des a	s on	n 1st			
						G	goes	low		51	ines]		
Н	L	×	Х	Х	Х					۲	L	L	L	Н		
		11	ntern	al Q	leve	ls ar	e san	ne								
н	н	f	uncti	on o	on of D inputs as on						L	L	L	н		
		fi	irst 5	line	s											

H = high level, L = low level, X = irrelevant

logic diagram (positive logic)



TEXAS INSTRUMENTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .																	•	•	•		•		7	V
Input voltage																							5.5	٧
Interemitter voltage (see Note 2)																							5.5	٧
Operating free-air temperature range:		N:	54	27	8	Ci	rcu	iits											— Е	i5°	C.	to	125°	,C
Cportaining in an earrich assessment and	5	SN'	74	27	8	Ci	rcu	iits												()°C) to	o 70°	,C
Storage temperature range																			-6	ն5°	,C	to	150°	,C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter transistor. For this circuit, this rating applies between the strobe input and any of the four data inputs.

recommended operating conditions

	S	SN54278					UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800	ļ		-800	μΑ
Low-level output current, IOL			16			16	mΑ
Data setup time, t _{SU} (see Figure 1)	20			20			ns
Data hold time, th (see Figure 1)	5			5			ns
Strobe pulse width, t _W (see Figure 1)	20			20			ns
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

-	PARAMETER		TEST CO	NDITIONS [†]	MIN	TYP	MAX	UNIT
VIH	High-level input voltage				2			V
VIL	Low-level input voltage						0.8	٧
VIK	Input clamp voltage		V _{CC} = MIN,	1 ₁ = -12 mA			-1.5	٧
VOH	High-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -800 μA	2.4	3.4		v
V _{OL}	Low-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 16 mA		0.2	0.4	V
1,	Input current at maximum input volta	ge	V _{CC} = MAX,	V ₁ = 5.5 V			1	mΑ
•	High-level input current	Any D input					80	
ιн		P0 input	V _{CC} = MAX,	$V_{i} = 2.4 V$			200	μΑ
•••		G input					320	
		Any D input					-3.2]
IJL	Low-level input current	P0 input	V _{CC} = MAX,	V _I = 0.4 V			8	mA
		G input			J		-12.8	
			V - MAY	SN54278	-18		-55	mA
los	Short-circuit output current §		V _{CC} = MAX	SN74278	-18		-57	<u> '''' </u>
¹ CC	Supply current		V _{CC} = MAX,	See Note 3		55	80	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

NOTE 3: ICC is measured with the P0 input grounded, all other inputs at 4,5 V, and outputs open.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

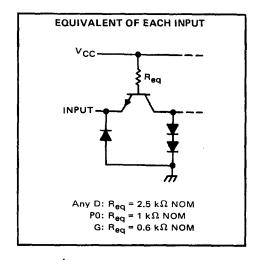
[§] Not more than one output should be shorted at a time.

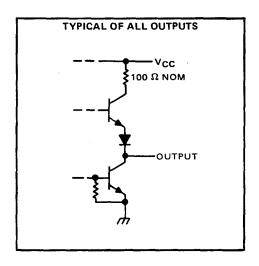
switching characteristics, VCC	: = 5	٧.	TΔ	=	25°	С
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PARAMETER†	FROM (INPUT)	TO (OUTPUT)	WAVEFORMS	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT	
tPLH	Data	Y	A and C				30		
^t PHL	Data		(with strobe high)				39	ns	
^t PLH	Data	Y	A and D				38		
^t PHL		'	(with strobe high)				31	ns	
^t PLH	Data	P1	A and E	C _L = 15 pF, R _L = 400 Ω, See Figure 1			46		
tPHL	Data) "	(with strobe high)				39	ns	
tPLH	Strobe	Any Y	B and C				30		
tPHL	311000	Any t	or B and D				31	ns	
tPLH .	Strobe	P1	B and E				38		
tPHL	Strobe	, ,	B and C				42	ns	
tPLH	PO	D4 5							
†PHL	FU	P1	F and G				30	ns	

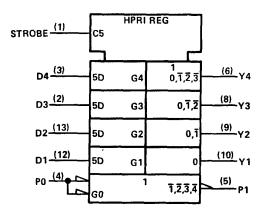
 $^{^{\}dagger} t_{PLH} = propagation delay time, low-to-high-level output$

schematics of inputs and outputs





logic symbol†

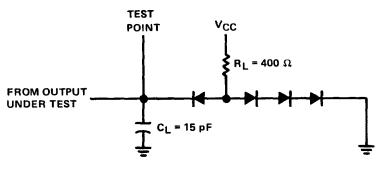


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



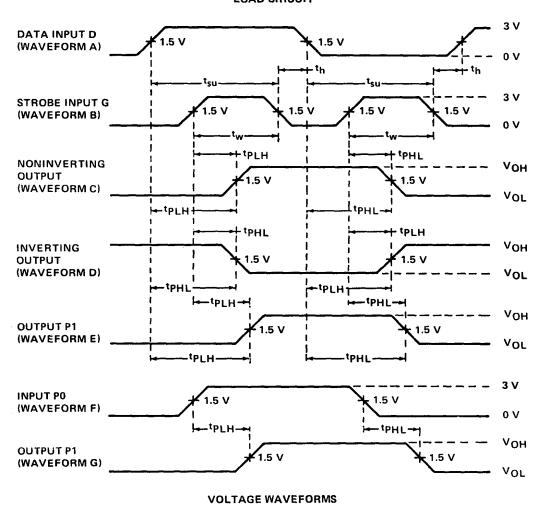
tpHL = propagation delay time, high-to-low-level output

PARAMETER MEASUREMENT INFORMATION



 C_L includes probe and jig capacitance. All diodes are 1N3064.

LOAD CIRCUIT



NOTE: Input pulses are supplied by a generator having the following characteristics: $t_r \le 7$ ns, $t_f \le 7$ ns, PRR $\le MHz$, $Z_{out} \approx 50\Omega$.

FIGURE 1-SWITCHING TIMES



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